



Dimpling Ductile Materials

Why Dimple TEM Specimens?

Dimpling has become the preferred first step in TEM specimen preparation because (1) it greatly reduces the time necessary for final thinning to electron transparency (the time saving is especially great when the final polishing step is relatively slow as is the case in ion polishing), (2) the electron transparent area will always form at the center of the specimen disc and hence less Xray shadowing will occur during EDX analysis and less specimen movement will occur during tilting (3) the thick, supportive rim of material formed during dimpling greatly facilitates the handling of fragile, TEM specimens.

Dimpling ductile materials

We are frequently asked by our customers to recommend a

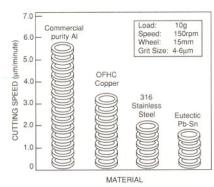


SEM image of a 316 stainless steel TEM specimen disc after grinding (left)and polishing (right) with CBN.

procedure for dimpling ductile materials, such as pure metals and solders. The problem usually encountered is that the cutting rate is low in comparison to that achieved with harder materials such as metal oxides and semiconductors. The reason for this is that the polishing grit (usually diamond or aluminum oxide) embeds itself in the soft material during dimpling and then the dimpling wheel starts to be ground away rather than the specimen. The solution to the problem is to use cubic boron nitride (CBN) as the polishing compound. CBN particles have a rounded shape and do not become so easily embedded in the materials being polished.

Recommended Procedure

We recommend that the starting thickness of the ductile material be somewhere in the range 100 to 150µm. Cut 3mm diameter specimen discs from this material using the GATAN Model 659 Disc Punch. Fit the Model 656 Dimple Grinder with a 15mm or 20mm diameter phosphor bronze wheel and dimple the 3mm discs using 4-6µm CBN grit down to a thickness of about 10µm. Install a felt wheel and continue polishing first with 4-6μm and then with 0-2μm CBN grit until the coarse marks formed during grinding by the 4-6µm grit have all been removed. Use



Dimpling rates for some common ductile materials using CBN paste.

sperm whale oil substitute as a lubricant to keep the CBN paste from drying out during both the grinding and polishing steps.

Measurement of cutting rates

Aluminum, stainless steel, copper and a Pb-Sn eutectic solder were each thinned from about 100μm to <10μm with 4-6μm CBN paste, a dimpling load of 10g, a wheel speed of 150rpm and a wheel diameter of 15mm. The bar graph shows the various cutting rates obtained. It can be seen that CBN cuts soft materials at about 2-6μm/min which is the same rate that diamond cuts silicon under similar conditions.

Ordering

GATAN provides CBN paste in convenient 5g syringes. 0-2µm CBN: 656-04-010 4-6µm CBN: 656-04-011

Gatan Inc.

Gatan GmbH Gatan Ltd. 6678 Owens Drive, Pleasanton, CA 94588, USA 780 Commonwealth Drive, Warrendale, PA 15086, USA Ingolstädter Straße 40, D-8000 München 45, Germany 3 Saxon Way E, Oakley Hay, Corby, Northants, NN18 9EY,UK

Tel 510 463 0200 Tel 412 776 5260 Tel 089 352 374 Tel 536 743 150 Fax 510 463 0204 Fax 412 776 3360 Fax 089 359 1642 Fax 536 743 154